

SUPPLEMENTAL / BID BULLETIN

UNIVERSITY OF THE PHILIPPINES MANILA

The Health Sciences Center

Bids and Awards Committee 1

Taft Avenue, Manila Trunk Line No. 8554-8400 Local 3014/3015



BID BULLETIN NO. 2024-034

for the Preventive Maintenance with Priority Parts for Existing Radiography and Radio-Fluoroscopy Machines 14 March 2024

Pursuant to Section 22.5.1 of the 2016 Revised Implementing Rules and Regulations of Republic Act No. 9184, the Bids and Awards Committee 1 is issuing this bid bulletin to modify or amend the following items in the Bid Documents:

The following should be modified in the Section I. Invitation to Bid as:

Item No.	From	То		
6	The UPM-PGH will hold a Pre-Bid Conference	The UPM-PGH will hold a Pre-Bid Conference		
	on 15 March 2024, 9:30AM at Conference on 15 March 2024, 9:30AM at Co			
	Room, BAC1 Office, UPM-Philippine General	Room, BAC1 Office, UPM-Philippine General		
	Hospital, PGH Compound, Taft Avenue,	Hospital, PGH Compound, Taft Avenue,		
	Ermita, Manila and/or through video	Ermita, Manila which shall be open to		
	conferencing or webcasting via ZOOM, which	prospective bidders.		
	shall be open to prospective bidders.			

The following should be modified in the Section II. Instruction to Bidders as:

Item No.	From	То
8	Pre-Bid Conference	Pre-Bid Conference
	The Procuring Entity will hold a pre-bid conference for this Project on the specified date and time and either at its physical address at the BAC1 Conference Room, BAC1 Office, PGH Compound, Taft Avenue, Ermita, Manila and/or through ZOOM as indicated in paragraph 6 of the IB.	The Procuring Entity will hold a pre-bid conference for this Project on the specified date and time and either at its physical address at the BAC1 Conference Room, BAC1 Office, PGH Compound, Taft Avenue, Ermita, Manila as indicated in paragraph 6 of the IB.

This shall form an integral part of the Bid Documents.

For the information and guidance of all concerned.

Dean CHARLOTTE M. CHIONG, MD, PhD *Chairperson, Bids and Awards Committee 1*

Received	l by	the	Bid	der:
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Signature over Printed Name

Name of Company

Date